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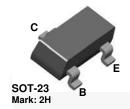


March 2014

MMBTA55 PNP General-Purpose Amplifier

Description

This device is designed for general-purpose amplifier applications at collector currents to 300 mA. Sourced from process 73.



Ordering Information

Part Number	Marking	Package	Packing Method
MMBTA55	2H	SOT-23 3L	Tape and Reel

Absolute Maximum Ratings(1),(2)

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at $T_A = 25^{\circ}C$ unless otherwise noted.

Symbol	Parameter	Value	Unit
V _{CEO}	Collector-Emitter Voltage	-60	V
V _{CBO}	Collector-Base Voltage	-60	V
V_{EBO}	Emitter-Base Voltage	-4	V
I _C	Collector Current - Continuous	-500	mA
T_{J} , T_{STG}	Junction and Storage Temperature Range	-55 to +150	°C

Notes:

- 1. These ratings are based on a maximum junction temperature of 150°C.
- 2. These are steady-state limits. Fairchild Semiconductor should be consulted on applications involving pulsed or low-duty-cycle operations.

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Thermal Characteristics(3)

Values are at $T_A = 25$ °C unless otherwise noted.

Symbol	Parameter	Max.	Unit
В	Total Device Dissipation	350	mW
P_{D}	Derate Above T _A = 25°C	2.8	mW/°C
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	357	°C/W

Note:

3. Device mounted on FR-4 PCB 1.6 inch X 1.6 inch X 0.06 inch.

Electrical Characteristics

Values are at $T_A = 25$ °C unless otherwise noted.

Symbol	Parameter	Conditions	Min.	Max.	Unit
V _{(BR)CEO}	Collector-Emitter Breakdown Voltage ⁽⁴⁾	I _C = -1.0 mA, I _B = 0	-60		V
V _{(BR)CBO}	Collector-Base Breakdown Voltage	$I_C = -100 \mu A, I_E = 0$	-60		V
V _{(BR)EBO}	Emitter-Base Breakdown Voltage	$I_E = -100 \mu A, I_C = 0$	-4.0		V
I _{CEO}	Collector Cut-Off Current	$V_{CE} = -60 \text{ V}, I_{B} = 0$		-0.1	μΑ
I _{CBO}	Collector Cut-Off Current	$V_{CB} = -60 \text{ V}, I_{E} = 0$		-0.1	μΑ
h _{FE}	DC Current Gain	$I_C = -10 \text{ mA}, V_{CE} = -1.0 \text{ V}$	100		
		$I_C = -100 \text{ mA}, V_{CE} = -1.0 \text{ V}$	100		
V _{CE} (sat)	Collector-Emitter Saturation Voltage	I _C = -100 mA, I _B = -10 mA		-0.25	V
V _{BE} (on)	Base-Emitter On Voltage	$I_C = -100 \text{ mA}, V_{CE} = -1.0 \text{ V}$		-1.2	V
f _T	Current Gain - Bandwidth Product	I_C = -100 mA, V_{CE} = -1.0 V, f = 100 MHz	50		MHz

Note:

4. Pulse test: pulse width \leq 300 μ s, duty cycle \leq 2.0%.

Physical Dimensions

SOT-23 0.95 2.92±0.20 3 1.40 1.30^{+0.20}_{-0.15} 2.20 0.60 0.37 (0.29) -0.95 ⊕ 0.20M A B 1.00 1.90 1.90 LAND PATTERN RECOMMENDATION 1.20 MAX SEE DETAIL A (0.93)0.10 ○ 0.10 M C C 2.40±0.30 NOTES: UNLESS OTHERWISE SPECIFIED **GAGE PLANE** A) REFERENCE JEDEC REGISTRATION TO-236, VARIATION AB, ISSUE H. B) ALL DIMENSIONS ARE IN MILLIMETERS. 0.23 0.08 C) DIMENSIONS ARE INCLUSIVE OF BURRS. 0.25 MOLD FLASH AND TIE BAR EXTRUSIONS. D) DIMENSIONING AND TOLERANCING PER ASME Y14.5M - 1994. 0.20 MIN E) DRAWING FILE NAME: MA03DREV10 SEATING **PLANE** (0.55)

Figure 1. 3-LEAD, SOT23, JEDEC TO-236, LOW PROFILE (ACTIVE)

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DETAIL A

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Definition of Terms			
Datasheet Identification	Product Status	Definition	
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Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.	
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.	
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